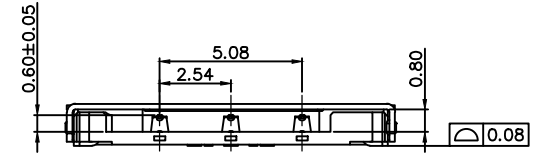
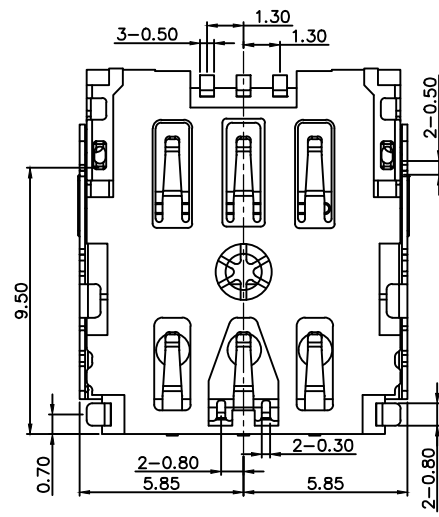
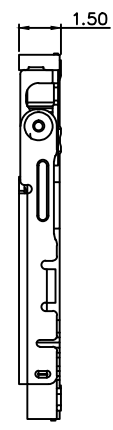
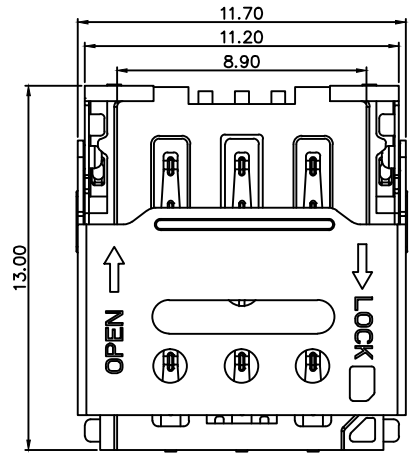


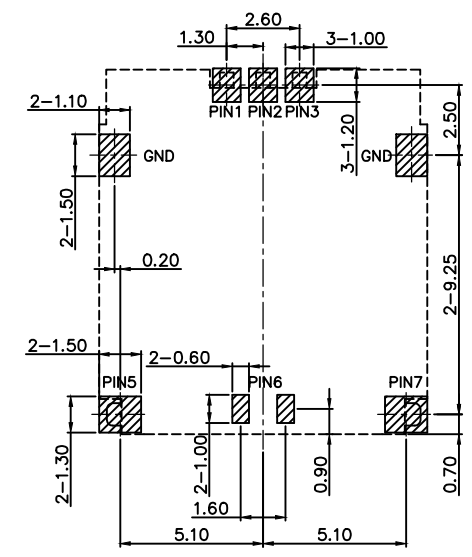
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A0		NEW	2017/03/13

NOTES:

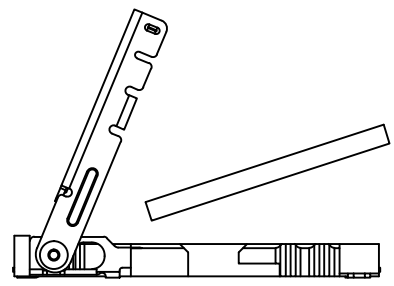
- MATERIAL:
 - 1-1 HOUSING: THERMOPLASTIC, UL94 V-0 . COLOR;BLACK
 - 1-2 SHELL; STAINLESS STEEL T=0.20mm
 - 1-3 CONTACT: COPPER ALLOY T=0.15mm
- FINISH:
 - 2-1 CONTACT: 1u" AU MIN. ON CONTACT AREA
GOLD FLASH ON SOLD AREA.
 - 50u" NI MIN. UNDERPLATING OVER ALL



SIM CARD PIN ON	NAME
PIN_1	VCC
PIN_2	RST
PIN_3	CLK
PIN_5	GND
PIN_6	VPP
PIN_7	I/O



RECOMMENDED PCB LAYOUT
TOP VIEW (TOLERANCE:±0.05)



STEP 1 INSERT NANO SIM CARD



STEP 2 PUSH THE SHELL

GENERAL TOLERANCE		DWG NO.	JYSA0620-001	APPD:	Kun	Scale	1:1
X.±0.45	x.±5'	Title	Nano Sim 掀盖式H=1.50mm	CHKD:		UNIT	mm
.X±0.35	.x'±2'			DR:			
.XX±0.25	.xx'±1'	Part NO.	JYS-SIM150-163	Date	2017/03/13		
.XXX±0.15	.xxx'±0.5'			Shenzhen		JYSCONN Electronics Co., LTD.	
SHEET	1/1						